

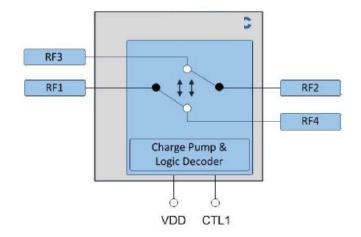
Product Overview

The QPC6222 is a dual-pole double-throw transfer switch designed for general purpose switching applications where RF port transfer (port swapping) control is needed. The low insertion loss along with excellent linearity performance makes the QPC6222 ideal for multi-mode GSM, EDGE, UMTS, and LTE applications.

The RF ports can be directly connected in $50\,\Omega$ systems and control logic is compatible with +1.3 V to +2.7 V systems. The supply voltage is intended for connection to +2.8 V systems but the device is operable from +2.4 V to +3.5 V.

The standard 12-pin QFN package and compact $2.0\,\mathrm{mm}$ x $2.0\,\mathrm{mm}$ size offers designers a compact, easy-to-use, switch component for quick integration into multimode, multi-band systems.

Functional Block Diagram



Functional Block Diagram

Top View



12 Pad 2.0 mm x 2.0 mm x 0.55 mm QFN Package

Key Features

- Low Insertion Loss
- High Port-to-Port Isolation
- Power Handling up to +35 dBm
- GPIO Interface for +1.3 V to +2.7 V Control Logic
- Broadband Performance Suitable for All Cellular Modulation Schemes up to 2.7 GHz
- Very Low Current Consumption
- Linearity and Harmonic Performance Ideally Suited for LTE Applications

Applications

- Data Cards
- IoT
- Telemetry
- Automotive
- · Cellular Modems and USB Devices
- Mult-Mode WCDMA, LTE Applications

Ordering Information

Part No.	Description
QPC6222SB	Sample Bag with 5 pieces
QPC6222SR	Sample Reel with 100 pieces
QPC6222PCK401	Assembled EVB + 5 Pieces Sample Bag
QPC6222TR13-5K	5000 Pieces Taped on 13" Reel

Absolute Maximum Ratings

Parameter	Rating
Storage Temperature	−65 to +150 °C
Operating Temperature (Tcase)	−40 to 105 °C
Maximum VDD	+4.5 V
Maximum CTRL	+3.0 V
Max Input Power (Momentary Infrequent Occurrence)	+38.5 dBm, 1:1 VSWR, +25°C +37.5 dBm, 1:1 VSWR, +90°C +35.0 dBm, 6:1 VSWR, +25°C +34.5 dBm, 6:1 VSWR, +90°C
Max Input Power (Continuous Operation)	+36.5 dBm, 1:1 VSWR, +25°C +35.5 dBm, 1:1 VSWR, +90°C +34.5 dBm, 6:1 VSWR, +25°C +34.0 dBm, 6:1 VSWR, +90°C

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability.

Recommended Operating Conditions

Parameter	Min	Тур	Max	Units
Device Voltage (V _{DD})	+2.4	+2.8	+3.5	V
VDD Supply Current		75	100	μA
CTL1 Logic Low Voltage	0.00	0.00	+0.45	V
CTL1 Logic High Voltage	+1.3	+1.8	+2.7	V
CTL1 Logic High Current		0.1	5	μA
Turn-On Time (1)			20	μs
Switching Time (2)			5	μs

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions.

Notes:

- 1. RF settling time with 0V to 2.4V step on VDD
- 2. Switching Time is measured at 10% to 90% RF

Electrical Specifications Low Band

Parameter		Conditions ⁽¹⁾	Min	Тур	Max	Units	
Operational Frequency Range			698		960	MHz	
	RF1 to RF3	Logic State = RF1 – RF3, RF2 – RF4		0.35	0.52		
Insertion Loss	RF1 to RF4	Logic State = RF1 – RF4, RF2 – RF3		0.35	0.52	dD.	
IIISEI IIOII LOSS	RF2 to RF3	Logic State = RF1 – RF4, RF2 – RF3		0.35	0.52	dB	
	RF2 to RF4	Logic State = RF1 – RF3, RF2 – RF4		0.34	0.52		
Isolation	RF1 to RF3, RF2 to RF4	Logic State = RF1 – RF4, RF2 – RF3	29	32		40	
isolation	RF1 to RF4, RF2 to RF3	Logic State = RF1 – RF3, RF2 – RF4	28	31		– dB	
	2nd Harmonic	Fragues and a 224 MHz. DINI = 125 dDrs. CW		-105	-76	dBc	
	3rd Harmonic	Frequency = 824 MHz, PIN = +35 dBm, CW		-88	-76	dBc	
	2nd Harmonic (B13)	Frequency = 786.5 MHz, PIN = +26 dBm, CW		-106	-98	dBc	
Harmonics	2nd Harmonic			-107	-100	dBc	
	3rd Harmonic	Frequency = 824 MHz to 915 MHz,		-106	-98	dBc	
	Up to 12.75 GHz	PIN = +26 dBm, CW		-105	-95	dBc	
IP2 Band 5 & 6 IP3 Band 5 & 6		F1 = 836.5 MHz, P_{F1} = +20 dBm, F2 = 1718 MHz, P_{F2} = -15 dBm, Rx Freq. = 881.5 MHz	110	128		dBm	
		F1 = 836.5 MHz, P_{F1} = +20 dBm, F2 = 791.5 MHz, P_{F2} = -15 dBm, Rx Freq = 881.5 MHz, Measured on all through paths	70	72		dBm	
VSWR		824 MHz to 960 MHz (RF1, RF2, RF3, RF4)		1.1	1.3		

Notes:

^{1.} Unless otherwise stated: all unused RF ports terminated in 50 Ω, Input and Output = 50 Ω, T. = +25 °C, V_{DD} = +2.4V, Logic State = RF1-RF4, RF2-RF3 and RF1-RF3, RF2-RF4

Electrical Specifications – High Band

Parameter		Conditions ⁽¹⁾		Min	Тур	Max	Units
Frequency Rar	Frequency Range		1427		2170	MHz	
	RF1 to RF3	Logic State = RF1-RF3: RF2-RF4	1427 to 1980 MHz		0.44	0.62	
			1980 to 2170 MHz		0.47	0.63	
	DE4 to DE4	Lagia Ctata - DE4 DE4: DE2 DE2	1427 to 1980 MHz		0.44	0.62	
lacoution Loca	RF1 to RF4	Logic State = RF1-RF4; RF2-RF3	1980 to 2170 MHz		0.47	0.63	٩D
Insertion Loss	DE0.4- DE0	Laria Otata DEA DEA DEO	1427 to 1980 MHz		0.44	0.62	dB
	RF2 to RF3	Logic State = RF1-RF4, RF2-RF3	1980 to 2170 MHz		0.47	0.63	
	DE0.4- DE4	Laria Otata DEA DEO DEA	1427 to 1980 MHz		0.44	0.62	
	RF2 to RF4	Logic State = RF1-RF3, RF2-RF4	1980 to 2170 MHz		0.47	0.63	
	RF1 to RF3, RF2 to RF4	Logic State = RF1-RF4, RF2-RF3	1427 to 1980 MHz	23	27		
11-4:			1980 to 2170 MHz	22	26		ı.
Isolation	RF1 to RF4,	Logic State = RF1-RF3, RF2-RF4	1427 to 1980 MHz	21	25		dB
	RF2 to RF3		1980 to 2170 MHz	20	24		
	2nd Harmonic	Frequency = 1980 MHz, PIN = +33 dBm, CW,			-97	-75	
	3rd Harmonic	Measured on all through paths			-90	-70	
Harmonics	2nd Harmonic				-107	-98	dBc
	3rd Harmonic	Freq.= 1710 MHz to 1980 MHz, P _{IN} = +26 dBm, CW,			-104	-94	
	Up to 12.75 GHz	Measured on all through paths			-104	-94	
IP2 Band 2 (PCS)		F1 = 836.5 MHz, P_{F1} = +20 dBm, F2 = 1718 MHz, P_{F2} = -15 dBm Rx Freq = 881.5 MHz, Measured on all through paths		+110	+126		dBm
	Band II (PCS)	F1 = 1880 MHz, P _{F1} = +20 dBm, F2 = 1800	· ·	+70	+73		
IP3	24.14.11 (1. 33)	Rx Freq = 1960 MHz, Measured on all through paths			.,,		dBm
•	Band I (IMT)	F1 = 1950 MHz, P_{F1} = +20 dBm, F2 = 1760 MHz, P_{F2} = -15 dBm Rx Freq = 2140 MHz, Measured on all through paths			+73		-
VSWR RF1, F	RF2, RF3, RF4	1427 MHz to 2170 MHz			1.2	1.5	

Electrical Specifications – High Band LTE

Parameter		Conditions ⁽¹⁾		Тур	Max	Units
Frequency Rang	је		2500		2690	MHz
Insertion Loss		RFx to RFx		0.53		dB
Isolation	RF1 to RF3, RF2 to RF4	Logic State = RF1-RF4, RF2-RF3	21	24		dB
	RF1 to RF4, RF2 to RF3	Logic State = RF1-RF3, RF2-RF4	19	23		dB
Harmonics	2nd Harmonic	Frequency = 2500 MHz to 2570 MHz, P _{IN} = +26 dBm, CW,		-104	-95	dBc
Паппопісѕ	3rd Harmonic	All through paths		-104	-95	dBc
VSWR RF1, R	RF2, RF3, RF4	2500 MHz to 2570 MHz		1.4	1.55	
IIP2		F1 = 2535 MHz at +20 dBm, F2 = 120 MHz at −15 dBm, Rx Freq = 2655 MHz	+110	+116		dBm
IIP3		F1 = 2535 MHz at +20 dBm, F2 = 2415MHz at −15 dBm, Rx Freq. = 2655 MHz	+70	+72		dBm

Recommended Operating Power, 50Ω System

Frequency	Power at T=+85°C	Power at T=+105 °C	Theta-J(°C/W)	Input
5 MHz	+33 dBm	+30 dBm	246	Single RF path
20 MHz to 4 GHz	+36.5 dBm	+34.5 dBm	34.8	Single RF path
5 MHz	+32 dBm	+29 dBm	310	Dual RF path
20 MHz to 4 GHz	+35.5 dBm	+33.5 dBm	47	Dual RF path

Control Logic

Logic State	Description	V_{DD}	CTL1
Off	Off or Standby - low current state	0 V	Low
RF1-RF4, RF2-RF3	RF1 connected to RF4 and RF2 connected to RF3	"V _{DD} "	Low
RF1-RF3, RF2-RF4	RF1 connected to RF3 and RF2 connected to RF4	"V _{DD} "	High

NOTE: The switch is in the Off or Standby state only when the V_{DD} supply is low. The RF performance is undefined in the Off state.

Power ON and OFF sequence

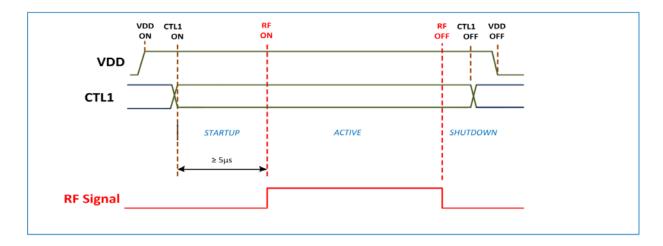
It is very important that the user adheres to the correct power-on/off sequence in order to avoid damaging the device. First apply V_{DD} before applying a high to CTL1.

Power ON -

- 1) Apply voltage supply V_{DD}
- 2) Apply logic signals CTL1
- 3) Wait 5 µs or greater after CTL1 are stable and then apply the RF Signal

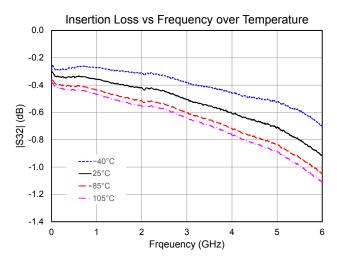
Power OFF -

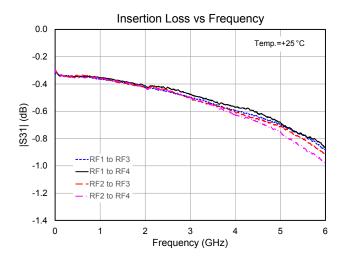
- 1) Remove the RF Signal
- 2) Remove logic signals CTL1
- 3) Remove voltage supply V_{DD}

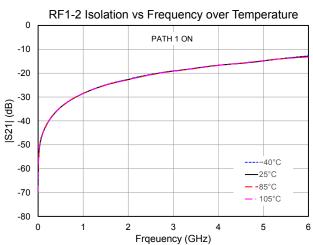


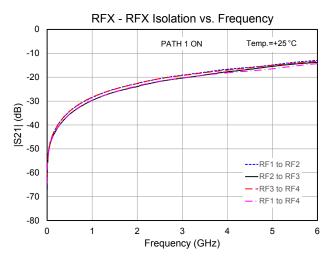
Performance Plots

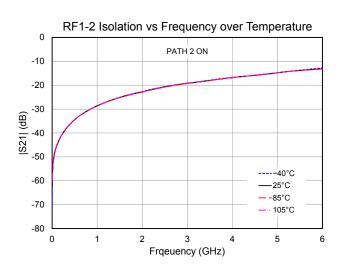
Test conditions unless otherwise noted: $V_{DD} = +2.8V$

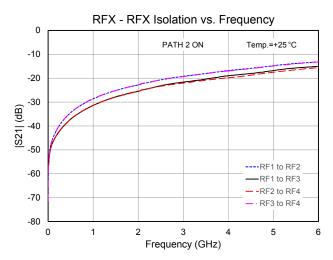






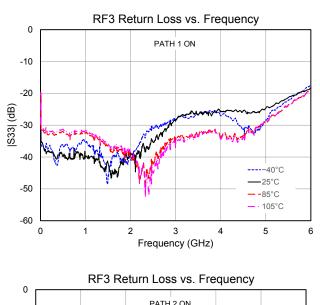


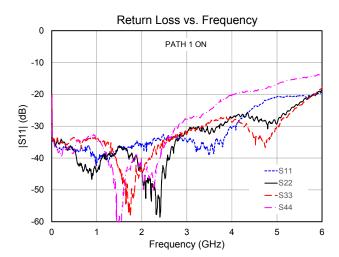


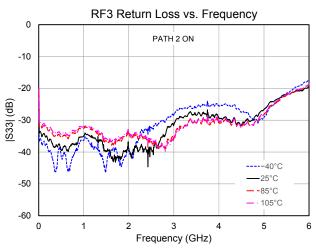


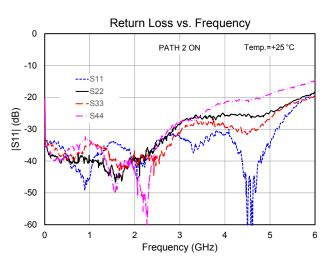
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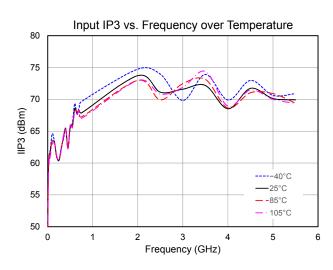
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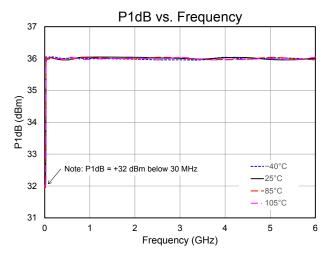






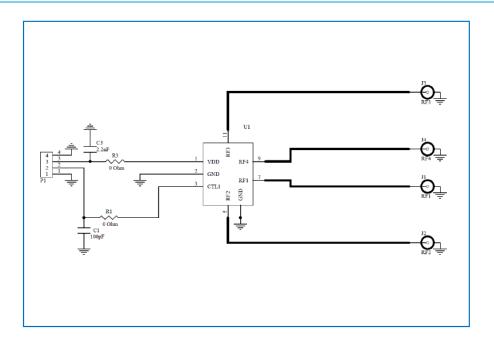




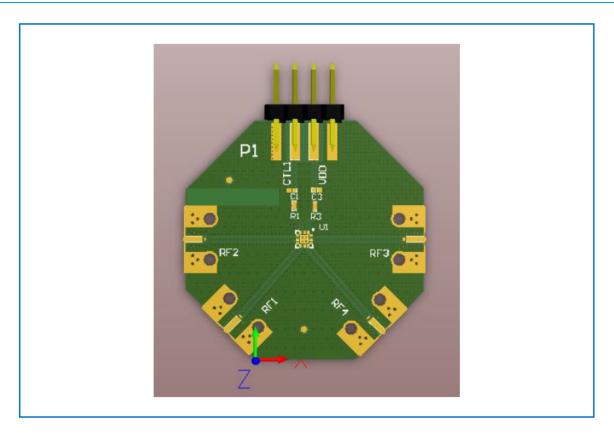




Evaluation Board Schematic

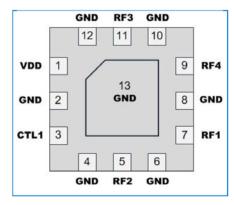


Evaluation Board Layout



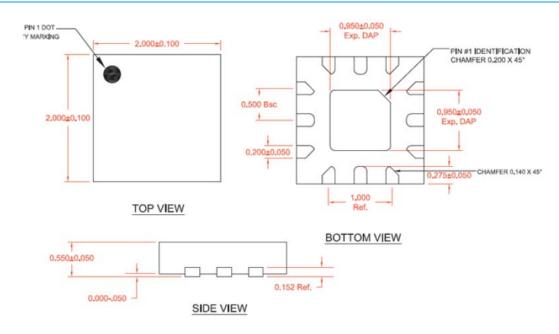


Pin Configuration and Description

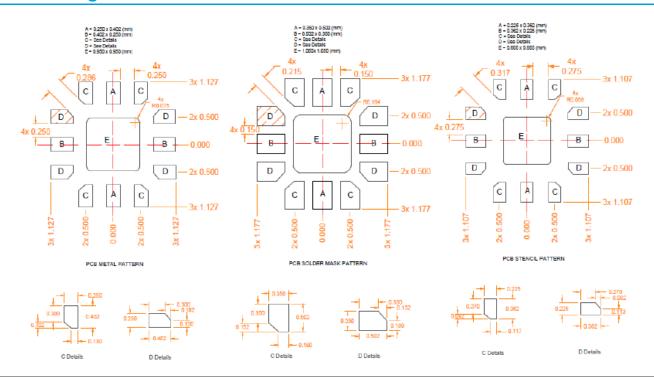


Pad No.	Label	Description
1	VDD	Power Supply.
3	CTL1	Logic control pin 1.
5	RF2	RF Port connecting to either RF3 or RF4. Avoid applying DC voltage.
7	RF1	RF Port connecting to either RF3 or RF4. Avoid applying DC voltage.
9	RF4	RF Port connecting to either RF1 or RF2. Avoid applying DC voltage.
11	RF3	RF Port connecting to either RF1 or RF2. Avoid applying DC voltage.
2, 4, 6, 8, 10,12,13	GND	GND.

Package Marking and Dimensions



PCB Mounting Patterns



Notes:

- 1. Thermal vias for center slug "E" should be incorporated into the PCB design. The number and size of thermanl vias will depend on the application, the power dissipation and the electrical requirements. An example of the number and size of the vias can be found on the Qorvo evaluation board layout.
- 2. Shaded pad in drawing above indicates pin 1 location.



Handling Precautions

	5 41	a		
Parameter	Rating	Standard	A	
ESD-Human Body Model (HBM)	Class 2C	ESDA/JEDEC JS-001-2012		Ca
ESD-Charged Device Model (CDM)	Class C3	JEDEC JESD22-C101F	184	ES
MSL – Moisture Sensitivity Level	MSL 1	IPC/JEDEC J-STD-020		

Caution! ESD-Sensitive Device

Solderability

Compatible with both lead-free (260°C max. reflow temp.) and tin/lead (245°C max. reflow temp.) soldering processes. Solder profiles available upon request.

Contact plating: NiPdAu

RoHS Compliance

This part is compliant with 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment) as amended by Directive 2015/863/EU.

This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A (C₁₅H₁₂Br₄O₂) Free
- PFOS Free
- SVHC Free



Contact Information

For the latest specifications, additional product information, worldwide sales and distribution locations:

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Email: customer.support@gorvo.com

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